雪隆机器厂商会 (PPM521/49) (*A member of FOMFEIA*)
The Selangor & Kuala Lumpur Foundry & Engineering Industries Association
8, 2nd Floor, Jalan 1/77B, Off Jalan Changkat Thambi Dollah, 55100 Pudu, K.L.
Tel : 03-21483461 / 21418843 Fax : 03-21422423
E-mail : admin@sfeia.org Website : www.sfeia.org

入会申请书
APPLICATION FOR MEMBERSHIP

注意：请用黑笔以正楷填写
Note : Please use black ball-point pen and write in block letters

1 **商号 Name of Company**
中文 (Chinese)
英文 (English)

2 地址 Address of Company

3 邮区 Postcode

4 电话号码 Tel No.

5 传真 Fax

6 电子邮件 E-mail

7 网址 Website

8 主要业务 Specialize in
中文 (Chinese)
英文 (English)

9 公司注册 日期 Company Regitration Date

10 公司注册 号码 Company Registration No.

敬请附上 Please attach with M & A Form 24 & 49

11 **代表姓名 Name of Representative**
中文 (Chinese) 英文 (English)

12 新身份证号码 New Identity Card No.

13 旧身份证号码 Old Identity card No

14 性别 Sex
男 Male 女 Female

15 职位 Designation

16 国籍 Nationality

17 住址 Residential Address

18 邮区 Postcode

19 电话 Tel No.

20 手机号码 H/P No.

本公司欲申请加入雪隆机器厂商会为会员，并声明以上填写各项属实。 We hereby apply for admission to be member of The Selangor & Kuala Lumpur Foundry & Engineering Industries Association and declare that the particulars given above are true and correct.

随此附上支票号码: _____ 志银RM _____ 支付 "The Selangor & Kuala Lumpur Foundry & Engineering Industries Association" 或 "SFEIA" 作为以下的会员籍会费及入会基金。
Enclosed herewith a cheque no: _____ amounting to RM_____ payable to "The Selangor & Kuala Lumpur Foundry & Engineering Industries Association" or "SFEIA" being payment of membership fee and entrance fee.

☐ 永久会员 Permanent Member	RM 1,500.00	RM 500.00 入会基金Entrance Fee	共Total : RM2,000.00
☐ 普通会员 Ordinary Member	RM 240.00 每年/yearly x _____ 年year	RM 500.00 入会基金Entrance Fee	共Total : _____
☐ 公司赞助会员 Company Subscribing Member	RM 240.00 每年/yearly x _____ 年year	RM 500.00 入会基金Entrance Fee	共Total : _____
☐ 个人赞助会员 Personal Subcribing Member	RM 120.00 每年/yearly x _____ 年year	RM 300.00 入会基金Entrance Fee	共Total : _____

申请人签署 Signature of Applicant
姓名Name :
日期 Date :

介绍人签名 Signature of Proposal
姓名Name :
日期 Date :

上述申请在_____ 年 _____ 月_____ 日董事会会议通过批准。
The above application has approved by the Board of Directors meeting held on _____.

会长签名 President's Signature
姓名Name :

与AND

总务/ 财政签名 General Secretary's / Treasurer's Signature
姓名Name :